



Product Summary

| BV _{DSS} | RDS(ON) Max | ID Ta = +25°C |
|-------------------|-------------------------------|------------------|
| 20V | $24m\Omega @ V_{GS} = 4.5V$ | 7A |
| 200 | 28mΩ @ V _{GS} = 2.5V | 5A |

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Backlighting
- DC-DC Converters
- Power Management Functions

N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Low On-Resistance
- Low-Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN2024UVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

Mechanical Data

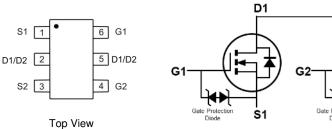
- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish—Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.013 grams (Approximate)





TSOT26

Protected Gate





D2

S2

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|----------------|--------|--------------------|
| DMN2024UVTQ-7 | TSOT26 | 3,000/Tape & Reel |
| DMN2024UVTQ-13 | TSOT26 | 10,000/Tape & Reel |

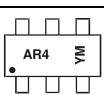
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\begin{array}{l} \mathsf{AR4} = \mathsf{Product Type Marking Code} \\ \mathsf{YM} = \mathsf{Date Code Marking} \\ \mathsf{Y or } \overline{\mathsf{Y}} = \mathsf{Year} \ (\mathsf{ex: I} = 2021) \\ \mathsf{M} = \mathsf{Month} \ (\mathsf{ex: 9} = \mathsf{September}) \end{array}$

Date Code Key

Notes:

| Year | 2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 | 2030 | 2031 |
|-------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | Н | | J | K | L | М | N | 0 | Р | R | S | Т |
| | | | | | | | | | | | | |
| Month | Jan | Feb | Mar | Apr | Мау | Jun | Jul | Aug | Sep | Oct | Nov | Dec |



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|---|--------|------------|-----------------|----|---|
| Drain-Source Voltage | VDSS | 20 | V | | |
| Gate-Source Voltage | VGSS | ±10 | V | | |
| Continuous Drain Current (Note 6) $V_{GS} = 4.5V$ | lo | 7.0 5.0 | А | | |
| Maximum Continuous Body Diode Forward Curr | ls | 2.3 | А | | |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = | 1%) | | I _{DM} | 35 | А |

Thermal Characteristics

| Characteristic | | Symbol | Value | Unit |
|--|--------------|------------------|-------------|------|
| Total Power Dissipation (Note 5) | | PD | 1.0 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | R _{eja} | 124 | °C/W |
| Total Power Dissipation (Note 6) | | PD | 1.6 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | Rəja | 78 | °C/W |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +150 | °C |

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-----|------|-----|------|---|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BVDSS | 20 | _ | — | V | $V_{GS} = 0V, I_D = 250 \mu A$ | |
| Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$ | IDSS | — | _ | 1.0 | μA | $V_{DS} = 20V, V_{GS} = 0V$ | |
| Gate-Source Leakage | lgss | — | _ | ±10 | μA | $V_{GS} = \pm 8V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | VGS(TH) | 0.5 | — | 0.9 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | |
| | | | 19 | 24 | | $V_{GS} = 4.5V, I_{D} = 6.5A$ | |
| Static Drain-Source On-Resistance | R _{DS(ON)} | — | 22 | 28 | mΩ | $V_{GS} = 2.5V, I_{D} = 5.5A$ | |
| | | | 25 | 34 | | V _{GS} = 1.8V, I _D = 3.5A | |
| Diode Forward Voltage | Vsd | — | 0.9 | 1.2 | V | $V_{GS} = 0V, I_D = 5A$ | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | - | | | | |
| Input Capacitance | Ciss | _ | 647 | | pF | | |
| Output Capacitance | Coss | — | 78 | — | pF | −V _{DS} = 10V, V _{GS} = 0V −f = 1.0MHz | |
| Reverse Transfer Capacitance | Crss | — | 38 | | pF | | |
| Gate Resistance | Rg | 100 | 400 | 800 | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$ | |
| Total Gate Charge | Qg | — | 7.1 | _ | nC | | |
| Gate-Source Charge | Qgs | — | 0.9 | — | nC | $V_{GS} = 4.5V, V_{DS} = 10V, I_{D} = 6.5A$ | |
| Gate-Drain Charge | Qgd | — | 0.7 | — | nC | | |
| Turn-On Delay Time | tD(ON) | _ | 98 | _ | ns | | |
| Turn-On Rise Time | tR | — | 140 | — | ns | $V_{DS} = 10V, V_{GS} = 4.5V,$ | |
| Turn-Off Delay Time | tD(OFF) | — | 1024 | — | ns | $R_L=10\Omega,\ R_G=6\Omega,\ I_D=1A$ | |
| Turn-Off Fall Time | tF | _ | 434 | — | ns | | |
| Reverse Recovery Time | trr | | 245 | | ns | IF = 1.0A, di/dt = 100A/µs | |
| Reverse Recovery Charge | Q _{RR} | — | 149 | — | nC | I _F = 1.0A, di/dt = 100A/µs | |

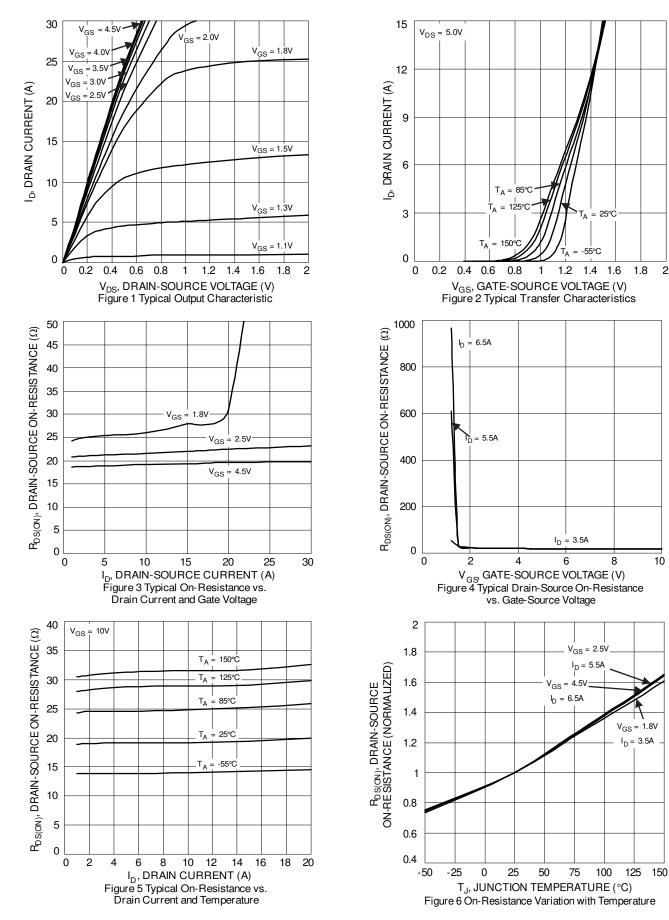
5. Device mounted on FR-4 PCB, with minimum recommended pad layout. Notes:

Device mounted on 1" x 1" FR-4 PCB with high-coverage 2oz. copper, single sided.
Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

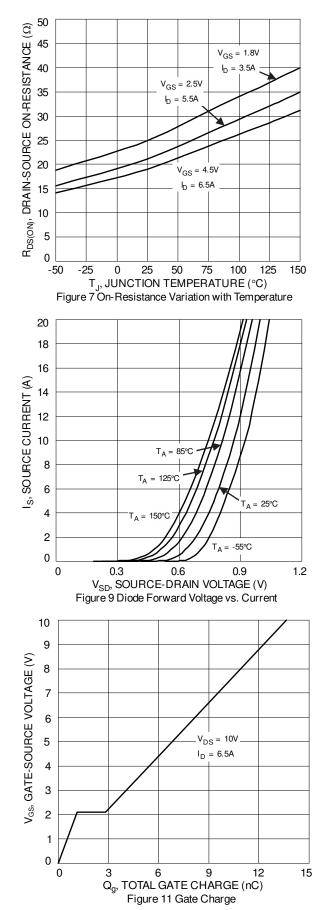


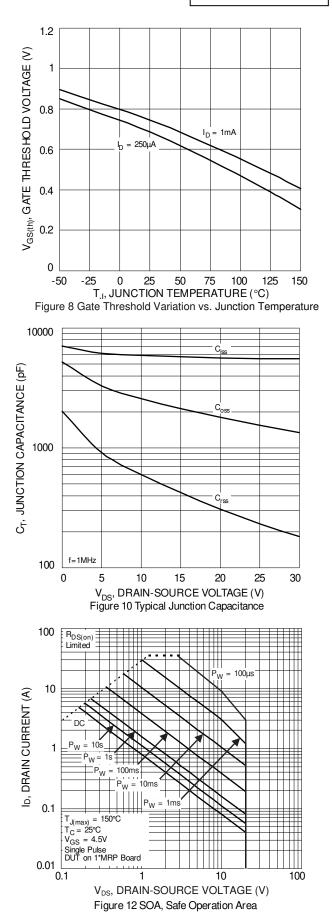
DMN2024UVTQ



DMN2024UVTQ Document number: DS42664 Rev. 2 - 2

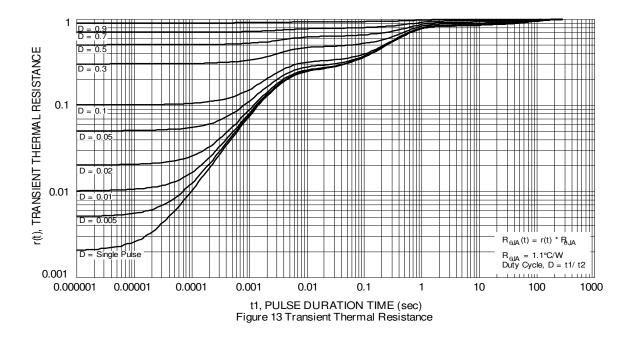






DMN2024UVTQ Document number: DS42664 Rev. 2 - 2

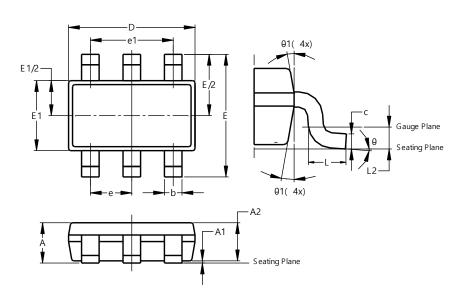






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

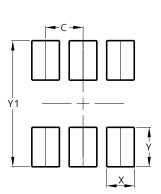


| TSOT26 | | | | | | | |
|--------|-------------|----------|-------|--|--|--|--|
| Dim | Min | Min Max | | | | | |
| Α | 1 | 1.00 | - | | | | |
| A1 | 0.010 | 0.100 | - | | | | |
| A2 | 0.840 | 0.900 | - | | | | |
| D | 2.800 | 3.000 | 2.900 | | | | |
| ш | 2 | .800 BS | С | | | | |
| E1 | 1.500 | 1.700 | 1.600 | | | | |
| q | 0.300 | 0.450 | - | | | | |
| c | 0.120 0.200 | | - | | | | |
| е | 0.950 BSC | | | | | | |
| e1 | 1 | .900 BS | С | | | | |
| L | 0.30 | 0.50 | - | | | | |
| L2 | 0.250 BSC | | | | | | |
| θ | 0° | 8° | 4° | | | | |
| θ1 | 4° | 12° | - | | | | |
| Α | II Dimen | sions in | mm | | | | |

TSOT26

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 0.950 |
| Х | 0.700 |
| Y | 1.000 |
| Y1 | 3.200 |

TSOT26



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